

COMPOSITE FORMING SMD INDUCTORS

CETC1040B TYPE

■Features

- RoHS compliant* and halogen free**
- Iowest DCR/uH,in this package size.
- High saturation current
- Frequency range up to 3.0MHZ.
- Ultra low buzz noise,due to composite construction.



■ Applications

- Notebook/Desktop/Server applications.
- low profile,high current power supplies.
- Battery powered devices.
- DC/DC converters.

■Product identification

1) Product Code

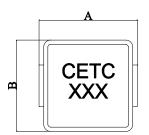
② Size: L×W (mm)

③ Inductance Value

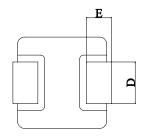
4 Tolerance: J±5%, K±10%, L±15%, M±20%, P± 25%, N±30%

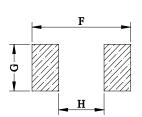
⑤ Category

■ Product Dimensions [unit: mn









■ Recommended Layout [unit: mm]

型号	A	В	С	D	E	F	G	Н
CETC 1040	11.2± 0.3	10± 0.5	4.0Max	3.0 ± 0.5	2.2 ± 0.4	13.6	4.1	5.4

■ Specification table

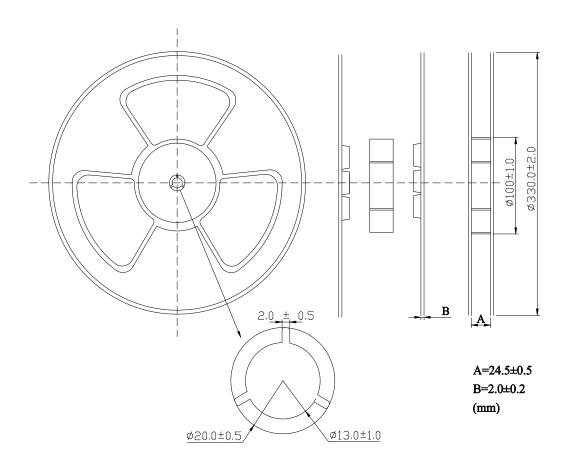
CETC1040-B series

DAI	100KHz 0.25V	D.C.R (mΩ)		Heat Rating Current	Saturation Current	
P/N	L0(μH) ±20% '@0A	Typical	Max	ldc (Amp) Typical	Isat (Amp) Typical	
CETC 1040-R22 M-B	0.22	0.85	1.0	30	50	
CETC 1040-R30 M-B	0.3	0.95	1.1	30	50	
CETC 1040-R47 M-B	0.47	1.35	1.5	28	40	
CETC 1040-R68 M-B	0.68	1.7	1.9	24	28	
CETC 1040-1R0 M-B	1.0	3.5	4.0	18	25	
CETC 1040-1R5 M-B	1.5	4.5	6.0	12	24	
CETC 1040-2R2 M-B	2.2	6.8	7.5	10	22	
CETC 1040-3R3 M-B	3.3	10.5	11.55	8	25	
CETC 1040-4R7 M-B	4.7	15	16.5	10	14	
CETC 1040-6R8 M-B	6.8	21	23	6.5	8	
CETC 1040-100 M-B	10	36	40	6	8	
CETC 1040-150 M-B	15	45	50	4.5	6.5	
CETC 1040-220 M-B	22	57	63	4	6.5	
CETC 1040-330 M-B	33	80	90	3.5	4	
CETC 1040-470 M-B	47	120	135	2.5	3	

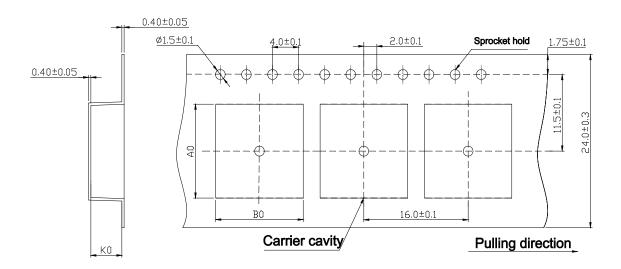
- All test data is referenced to 25°C ambient
- DC current (Isat) that will cause Lo to drop approximately 20%
- Operating temperature Range: -40°C to +125°C
- The part temperature (ambient + temp rise) should not exceed 125°C under the worst operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature. Part temperature should be verified in the end application.

■Packaging

1) Reel dimensions

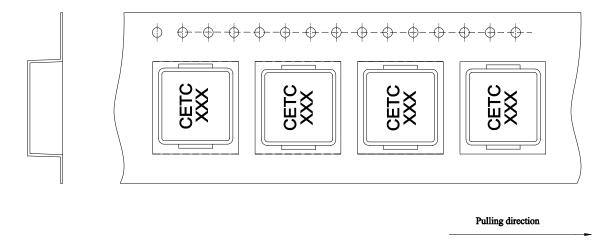


2) Tape packaging dimensions



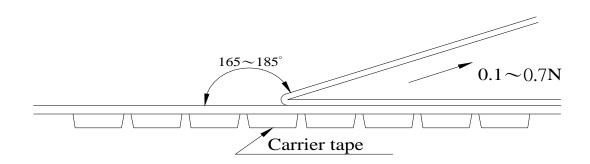
Dimensions Code (mm)						
A0	B0	K0				
10.9±0.1	10.73±0.1	4.3±0.05				

3) Tape Direction



4) Peel force of top cover tape

The peel speed shall be about 300 mm/minute
The peel force of top cover tape shall be between 0.1 to 1.3N



Numbers of taping: 700 pieces / reel.

Reminders

Please pay sufficient attention to the warnings for safe designing when using these products.

- The storage period is less than 12 months. Be sure to follow the storage conditions (Temperature: 5 to 40°C, Humidity:10 to 75% RHor less).
 - If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- * Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Before soldering, be sure to preheat components.
 The preheating temperature should be set so that the temperature difference between the solder temperature and chip temperaturedoes not exceed 150°C.
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications.
 - If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermaldesign.
- Do not expose the products to magnets or magnetic fields.
- X Do not use for a purpose outside of the contents regulated in the delivery specifications.